Designing R2CD Snubbers Using Standard Recovery Diodes

RCD snubbers are widely used to limit peak voltage stress in switch mode power supplies, SMPS. The idea of using a slow diode in this application, originating in China, has been floating around for some time. This paper looks at this configuration, which requires an extra resistor, and compares cost and performance of the two methods. Analytic predictions are confirmed using hardware test results for SMPS power rating from several Watts to several kilo Watts. The better configuration will prove to have superior performance across the board, lesser cost and immunity to variations in circuit parameters.

When a switch mode power supply, SMPS, switches OFF, the parasitic leakage inductance [1] that couples the primary and secondary winding of a transformer must be charged or discharged. In that brief instant, the resulting voltage transient must be stabilized in order to prevent circuit destruction caused by the sudden change in current transmitted to the leakage inductance. The test circuit shown in Figure 1 illustrates the phenomenon. The FET, Q1, charges the simulated leakage inductance when it is turned ON and releases the charge into the snubber circuit when it is turned OFF. The parameter blocks in the schematic are used to represent either RCD or R2CD (used when reverse recovery time, \(t_{rr}\), is > .5 microseconds) configurations. Snubber parameters are adjusted for each case to yield the same results. The FET should be the same device used in the final design in order to account circuit affects imposed by the actual device. The drain voltage reaches about 2 kVolts using this test circuit when the snubber is removed and avalanche does not occur.
Figure 1. Snubber test circuit examines theory.

If the snubber diode is conducting reverse current when it turns OFF, a negative transient voltage spike occurs at Q1 drain (typical RCD behavior). This spike results from discharging the residual leakage inductor current into Q1 and results in a damped ringing behavior when switch capacitance is included in the model. However, if a long t_{rr} diode is used, its possible to design the circuit so that the current is zero when the diode drops out of conduction; a high efficiency resonant condition.

Standard recovery diodes exhibit a long storage time that is characterized as t_{rr} in the data sheets. By convention, the standard recovery diodes have t_{rr} specified as greater than 0.5 microseconds; t_{rr} typically ranges from 2 microseconds to 5 microseconds, increasing with higher voltage rating. When the transient current in the snubber diode is shorter than t_{rr}, the stored charge can be removed just as the diode voltage approaches zero. Figure 2 shows the current waveform and its associated charge. Thus, an R2CD snubber operates properly for any t_{rr} that’s greater than \frac{1}{2} the period of snubber resonant frequency.
The R2CD snubber has an extra resistor, R1, in series with the diode. The trick in designing a resonant R2CD snubber is selecting R1 to damp the R1-L-C resonance such that
\[ R_1 = k \sqrt{L/C} \] (eq. 1) where k is between 1 and 2. Most of the power loss occurs in this resistor. The turn-off time of a diode is determined by the time required to remove its stored charge, possibly less than \( t_{rr} \). For an R2CD snubber, if the half period of resonance is small compared to \( t_{rr} \), then the diode turns off with no switching transient. As \( t_{rr} \) increases, there is no penalty, mitigating the dearth of specifications for these diodes. It’s especially noteworthy that EMI generated by the switching transient of a properly designed R2CD snubber is actually less than the RCD version. Figure 3 shows the simulation waveforms illustrating how the R2CD snubber works.

**Figure 2:** Snubber Current and Charge are zero at the end of the switching transient.
Three snubber configurations have been compared using a kilowatt level full bridge DC-DC converter. The output bridge drives a buck type L-C filter in a manner that produces a 120 VRMS full wave rectified sine wave. The input bridge is connected to a combination 48 Volt battery and solar panel battery charger. Bi-directional power conversion is required so that motor loads can be supplied as well as battery charging. Normally all transistors in the output bridge are turned on so that the load current flows through the transformer secondary. When power is needed, opposite output bridge switches are turned off and corresponding input bridge switches connect to the battery/charger system. Thus, the initially charged transformer leakage inductance must be discharged into a snubber. In this case, the snubber protects the high-side driver components because the switches are avalanche rated.

The RCD and R2CD snubbers are the same ones evaluated in the test simulation. A resonant snubber based on [2] was included in the evaluation. Figure 4 shows the results.
Figure 4, R2CD snubber has best overall efficiency below 1 kWatt.

Additional simulation and tests were run on a two Watt housekeeping power supply and are summarized in Figure 5. The simulation parameters were adjusted to match the test results. VR1 is the voltage across snubber resistor R1. The major adjustments were for leakage inductance (adjusted in the transformer model by changing the insulation thickness) and varying diode trr.

Figure 5, Two Watt R2CD snubber simulation compares favorably with lab test results.

Discussion:

Simulation Vs. Test: It is important to make test and simulation results agree. Once the simulation results
match the test results; then simulation parameters can
be varied in order to evaluate circuit performance for
varying tolerances and temperatures. Some of these
parameters; trr for example, can’t be varied by part
substitution. The equations describing snubber loss are
approximate and don’t include the complex behavior of
switched current, voltage and time. So like it or not,
simulation is a required design tool!

**RR2CD Topology:** Variations in the R2CD topology
yield the same results. These variations include moving
R1 to be anywhere in series with C; for example on
either side of the diode, the ground leg or in series with
C. Similarly, R can go anywhere after the snubber diode.
Placing R1 in the ground leg simplifies measuring
snubber current. C can be connected to ground or the
output. Connecting to the output increases conducted
EMI and reduces the required voltage rating.

**Leakage Inductance:** The power to be snubbed is
1/2LI^2F, so that minimizing leakage inductance is the
first priority. Leakage inductance is difficult to predict [1]
because magnetic device geometry depends on winding
techniques, Therefore, is necessary to measure leakage
inductance by shorting out the secondary windings.
Measuring leakage inductance is surprisingly more
complex than it appears. Consider an equivalent circuit
where magnetizing inductance is in parallel with a series
combination of leakage inductance and reflected winding
resistance. An LCR multimeter will report vastly different
results at 1 kHz vs. 100 kHz. For the circuit used in
Figure 5, the result is 168 uHy vs. 5 uHy. In any event,
the short circuit driving point impedance needs to be
compared to the simulation result in order to evaluate or
adjust the transformer model.

**EMI reduction:** The reduced EMI is caused by the
resonant charge characteristics (Figure 2.). To get the
best result R1 must be set based on L and C (eq. 1) so
that the only degree of freedom in the design is the
selection of C. As C increases, voltage clamping is
reduced but efficiency is reduced. R1 can be cut in half
(k=1 in eq.1) without much change in the EMI
characteristic in order to reduce the maximum voltage.

**Efficiency:** To calculate the RCD snubber power loss;
First, Calculate the power loss in a Zener clamped
snubber with no switch capacitance:

\[
Ton = \frac{L \cdot I_s}{(V_m - nV_s)} \quad \text{eq. 2}
\]

\[
P_z = V_m \frac{I_s}{2} \cdot Ton \cdot F \quad \text{eq. 3}
\]
\[ P_z = \frac{1}{2} L I_s^2 F \frac{V_m}{V_m - nV_s} \]  
\[ \text{eq. 4} \]

\[ P_z = P_L \frac{V_m}{V_m - nV_s} \]  
\[ \text{eq. 5} \]

Then replace the zener with a resistor having the same average current

\[ I_{avg} = \frac{P_z}{V_m} \]  
\[ \text{eq. 6} \]

\[ P_r = P_L \frac{V_m - V_s}{V_m - nV_s} \]  
\[ \text{eq. 7} \]

Where:
- \( V_m \) is the maximum or snubbed voltage
- \( V_s \) is the input voltage
- \( nV_s \) is the flyback voltage
- \( F \) is frequency
- \( L \) is the leakage inductance
- \( I_s \) is the switched current

The R2CD snubber loss is just PL, so the RCD snubber is flawed by not having available the proper voltage, \( nV_s \), to connect the bleed resistor.

Some of the energy of the switched leakage inductance is dissipated in the switching transistor. The R2CD configuration dissipates less of this energy in the switching transistor. Actual values depend on the transistor, its drive circuit and the direction of power flow.

For the R2CD snubber, \( R \) is used to control the final value of charge. Simulation can be used to find a value for \( R \) that minimizes EMI.

**Diode Selection:** The R2CD snubber diode relies on unspecified data sheet parameters. Two important parameters are storage time and the forward recovery characteristic [4]. Forward recovery occurs when the diode is switched on because of the low initial conductivity of the intrinsic region. For the R2CD snubber, the initial turn-on resistance, \( R_m \), can be used as a figure of merit. Table 1 lists the characteristics and cost for several common diodes. \( R_m \) and energy were based on test using a 5 Amp current pulse. Multiplying energy by operating frequency gives the power dissipation caused by forward recovery. The loss is expected to grow proportional to the square of current. Detailed test data is available [3].

**Table 1 Common Diode Data**
<table>
<thead>
<tr>
<th>Part Number</th>
<th>Rm</th>
<th>Energy</th>
<th>Cost</th>
</tr>
</thead>
<tbody>
<tr>
<td>1N4007 x3</td>
<td>5.3</td>
<td>3.70 uJ</td>
<td>$0.17</td>
</tr>
<tr>
<td>6A10DCT</td>
<td>5.4</td>
<td>3.99 uJ</td>
<td>$0.26</td>
</tr>
<tr>
<td>20ETS12</td>
<td>9.5</td>
<td>10.9 uJ</td>
<td>$1.79</td>
</tr>
</tbody>
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The 1n4007 used 3 devices in parallel and cost data for 500 quantities. All others used 100 quantities for pricing. Digi-Key was used for the price estimates. All \( trr \) values were in the acceptable range for the application. Notice the newer, "modern" technology diode had greater forward recovery loss and costs more. The 20ETS12 data was representative of 2 other part numbers (40EPS08 and D6020L) that were even more expensive. For reference, the DSEP8-12A fast recovery diode used in an RCD snubber costs $1.37.

**Test Circuit:** The circuit in Figure 1 simulates snubber loss so that testing can be accomplished at lower power. The actual circuit (Buck or Flyback) operates at much higher power.

**Conclusion:** The simulation results speak loudly! The R2CD snubber is more efficient, lower cost and produces less EMI. The popular misconception that diode storage time must equal the resonant \( \frac{1}{2} \) period is replaced by the requirement that storage time be greater than the resonant \( \frac{1}{2} \) period. More hardware tests are available along with the production and test drawings [3]. The R2CD snubber is surprisingly immune to circuit parameter variation; while limiting peak voltages for wide variations in R1, R, C and \( trr \).

**References:**


